

L Number	Hits	Search Text	DB	Time stamp
1	426	semiconductor and (under adj (ball or bump) adj metallurgy)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/10 16:43
2	66	(semiconductor and (under adj (ball or bump) adj metallurgy)) and vanadium and nickel	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/10 16:43